SLOVENSKI STANDARD
oSIST prEN IEC 63758-7:2026

01-november-2026

Specifikacija Qi - Različica 2.3 - 7. del: Magnetni pokrovi (hitri postopek)

Qi Specification - Version 2.3 - Part 7: Magnetic covers (Fast Track)

Sample Document

Ta slovenski standard je istoveten z: **prEN IEC 63758-7:2026**

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ICS:

29.240.99	Druga oprema v zvezi z omrežji za prenos in distribucijo električne energije	Other equipment related to power transmission and distribution networks
33.160.99	Druga avdio, video in avdiovizuelna oprema	Other audio, video and audiovisual equipment
35.200	Vmesniška in povezovalna oprema	Interface and interconnection equipment

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2003-01.Slovenski inštitut za standardizacijo. Razmnoževanje celote ali delov tega standarda ni dovoljeno.

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100/4550/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

PROJECT NUMBER: **IEC 63758-7 ED1**	
DATE OF CIRCULATION: **2026-09-18**	CLOSING DATE FOR VOTING: **2026-12-11**
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IEC TC 100 : AUDIO, VIDEO AND MULTIMEDIA SYSTEMS AND EQUIPMENT	
SECRETARIAT: Japan	SECRETARY: Ms Mahiru Uehara
OF INTEREST TO THE FOLLOWING COMMITTEES: TC 106,TC 108	HORIZONTAL FUNCTION(S):
ASPECTS CONCERNED:	
☒ SUBMITTED FOR CENELEC PARALLEL VOTING **Attention IEC-CENELEC parallel voting** The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting. The CENELEC members are invited to vote through the CENELEC online voting system.	☐ NOT SUBMITTED FOR CENELEC PARALLEL VOTING

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TITLE:

Qi Specification - Version 2.3 - Part 7: Magnetic covers (Fast Track)

PROPOSED STABILITY DATE: 2029

NOTE FROM TC/SC OFFICERS:

As this is a fast-track process offered by WPC, the Word file is not provided.

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WIRELESS POWER

CONSORTIUM

Qi Specification

Magnetic Covers

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Version 2.3

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1. General

The Wireless Power Consortium (WPC) is a worldwide organization that aims to develop and promote global standards for wireless power transfer in various application areas. An important application area comprises flat-surface devices such as mobile phones and chargers operating at power levels up to 25 W.

1.1 Structure of the Qi Specification

General documents

- Introduction
- Glossary, Acronyms, and Symbols
- Technical System Overview
- Power Profiles

System description documents

- Mechanical, Thermal, and User Interface
- Power Delivery
- Communications Physical Layer
- Communications Protocol
- Foreign Object Detection
- NFC Tag Protection
- Authentication Protocol
- MPP Communications Protocol
- MPP Magnetics Design
- MPP Power Delivery
- MPP Communications Physical Layer
- MPP Foreign Object Detection
- MPP Design Guidelines (Informative)
- Magnetic Covers
- Active Alignment System
- Thermal Management Protocol

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